

UNISONIC TECHNOLOGIES CO., LTD

L1188 Preliminary CMOS IC

800mA CMOS LDO

■ DESCRIPTION

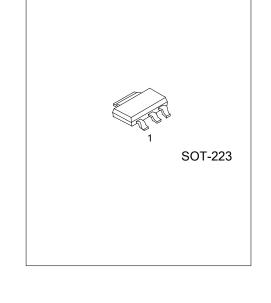
As UTC LDO, the features of the UTC **L1188** include low quiescent current and very low dropout voltage.

In order prevent form the bad operating conditions, there are internal thermal shutdown and current fold-back. For stably operation, the UTC **L1188** should be connected to an output capacitance of $2.2\mu F$ or larger.

The UTC **L1188** can be an ideal for battery applications, such as portable electronics, wireless devices, cordless phones, PC peripherals and battery powered widgets.

■ FEATURES

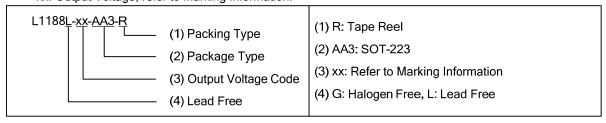
- * Extra Low Dropout Voltage
- * Output Current: 800mA (Guaranteed)
- * Output Voltage Accuracy: ±1.5%
- * Quiescent Current: 30uA
- * Internal Over-Temperature Shutdown
- * With Current limiting
- * Internal Short Circuit Current Fold-Back
- * Pre-set Output Voltages In Factory
- * Very Low Temperature Coefficient



■ ORDERING INFORMATION

Ordering	Daalaasa	Pin Assignment			De alsia a		
Lead Free	Halogen Free	Package	1	2	3	Packing	
L1188L-xx-AA3-A-R	L1188G-xx-AA3-A-R	SOT-223	G	0	ı	Tape Reel	

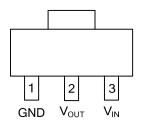
Note: Pin Assignment: G:GND $O:V_{OUT}$ $I:V_{IN}$ xx: Output Voltage, refer to Marking Information.



■ MARKING INFORMATION

PACKAGE	VOLTAGE CODE	MARKING				
SOT-223	28 :2.8V 33:3.3V	Pin Code L1188 G: Halogen Free L: Lead Free Voltage Code 1 2 3				

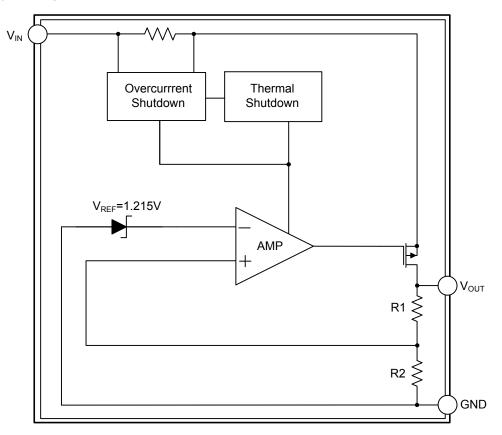
■ PIN CONFIGURATION



■ PIN DESCRIPTION

PIN NO.	PIN NAME	DESCRIPTION
1	GND	Ground.
2	V _{OUT}	Output voltage pin which should be decoupled with a ceramic capacitor (Value: 2.2µF or larger and low ESR).
3	V _{IN}	Input voltage pin which should be decoupled with 1µF or greater capacitor.

■ BLOCK DIAGRAM



■ ABSOLUTE MAXIMUM RATING

PARAMETER	SYMBOL	RATINGS	UNIT
Input, Output Voltage		GND - 0.3 ~ V _{IN} + 0.3	V
Input Voltage	V_{IN}	8	V
Output Current	I _{out}	1	Α
Power Dissipation	P _D	800	mW
Junction Temperature	T_J	125	°C
Ambient Operating Temperature	T _{OPR}	- 40 ~ + 85	°C
Storage Temperature	T _{STG}	- 65 ~ +150	°C

Notes: Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	θ_{JA}	135	°C/W
Junction to Case (Note)	θ_{JC}	31	°C/W

Note: Measure θ_{JC} on backside center of tab.

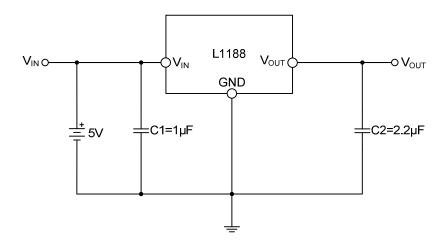
■ **ELECTRICAL CHARACTERISTICS** (T_A = 25°C, unless otherwise specified.)

PARAMETER	SYMBOL	TEST CONDITIONS		MIN	TYP	MAX	UNIT
Input Voltage	V_{IN}			Note1		7	V
Output Voltage Accuracy	V _{OUT}	I _{OUT} = 1mA		-1.5		1.5	%
Line Regulation		I _{OUT} =1mA V _{IN} =V _{OUT} +1~V _{OUT} +2	1.8V≤V _{OUT} ≤2.0V	-0.15		0.15	%
			2.0V <v<sub>OUT<4.0V</v<sub>	-0.1	0.02	0.1	%
			V _{OUT} ≥4.0V	-0.4	0.2	0.4	%
Load Regulation	ΔVουτ	I _{ошт} =1mA~800mA			0.2	1	%
Load Regulation	Vout	1001 - IIIA 3000IIIA		0.2	'	/0	
Output Current	I _{OUT}	V _{OUT} ≥1.8V		800			mA
Current Limit	I _{LIMIT}	V _{OUT} ≥1.8V		900			mA
Short Circuit Current	I _{SC}	V _{OUT} <0.8V			400	800	mA
Quiescent Current	IQ	I _{OUT} =0mA			30	50	μΑ
Ground Pin Current	I_{GND}	I _{OUT} =1mA ~ 800mA			35		μΑ
	V _D	I =000m A	1.8V≤V _{OUT(NOM)} ≤2.0V			1400	mV
Dropout Voltage		I _{OUT} =800mA V _{OUT} =V _{OUT(NOM)} -2.0%	2.0V <v<sub>OUT(NOM)≤2.8V</v<sub>			1000	mV
			2.8V <v<sub>OUT(NOM)</v<sub>			800	mV
Over Temperature Shutdown	OTS				150		°C
Over Temperature Hysteresis	OTH				30		°C
Temperature Coefficient of Output Voltage	T _C V _O				30		ppm/°C
Power Supply Ripple Rejection	PSRR	1 400 4	f=100Hz		60		dB
		I _{OUT} =100mA	f=1kHz		50		dB
		C _O =2.2μF	f=10kHz		20		dB
Output Voltage Noise	e _N	I _{OUT} =10mA, C _{OUT} =2.2μF, f=10Hz~100kHz			30		μV_{RMS}

Notes: 1. V_{IN(MIN)}=V_{OUT}+V_D

^{2.} To prevent the Short Circuit Current protection feature from being prematurely activated, the input voltage must be applied before a current source load is applied.

TYPICAL APPLICATION CIRCUIT



APPLICATION INFORMATION

1. Detailed Description

Internal circuits include: a PMOS pass transistor, voltage reference, error amplifier, over-current protection, and thermal shutdown.

The data through the error amplifier, over-current shutdown, and thermal protection circuits, then to the P-channel pass transistor.

As soon as the junction temperature exceeds 150°C or the current exceeds 900mA, over-current and thermal shutdown circuits start working. When the junction temperature drops below 120°C, normal operation is restored.

When the load exceeds the rated output current, for preventing the over stress, the chip switches from voltage mode to current mode.

2. External Information

When considering the external capacitors, the L1188 is stable with an output capacitor to ground of 2.2µF or greater. As we know, the ceramic capacitors have the lowest ESR but can offer the best AC performance; the aluminum electrolytic capacitors exhibit the highest ESR but offer the poorest AC response. And also large value ceramic capacitors are expensive. Consider all the situation, the best way is to parallel a 0.1µF ceramic capacitor with a 10µF Aluminum Electrolytic (low ESR, high capacitance, and low overall cost).

For better beneficial effecting, the input capacitor should be at least 0.1µF.

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